Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	23	"bond pad" with stagger$3 with edge and substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 14:18
L3	29	"bond pad" with stagger$3 with substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 14:18
L4	4	("5365409" | "5761048" | "5898213" | "6160313").PN. OR ("6531762").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/21 14:26
S1	1809	(257/686).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/18 11:14
S3	727	(438/109).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/18 12:45
S4	494	"area array" and cable and (ic or integrated near2 circuit or chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/18 12:47
S5	234	"area array" and cable and (ic or integrated near2 circuit or chip) and stack$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/18 12:47
S7	386	(terminal or ball) near2 pad and (connect$3 near2 pad) and staggered	US-PGPUB; USPAT	OR	ON	2005/04/18 16:40
S8	153	(terminal or ball) near2 pad and (connect$3 near2 pad) and staggered and straight	US-PGPUB; USPAT	OR	ON	2005/04/18 14:43
S9	320	flex$4 near2 circuit and (mcm or multi near2 chip) and stacked	US-PGPUB; USPAT	OR	ON	2005/04/18 14:53

S10	346	flex$4 near2 (circuit or pcb or printed) and (mcm or multi near2 chip) and stacked	US-PGPUB; USPAT	OR	ON	2005/04/18 15:51
S14	63	"Lee, Dong-Ho".in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/18 15:28
S15	107	flex$4 near2 (circuit or pcb or printed) and (mcm or multi near2 chip) and stacked and (bga or ball near2 grid near2 array)	US-PGPUB; USPAT	OR	ON	2005/04/18 16:03
S16	875	flex$4 near2 (circuit or pcb or printed or pwb) and (mcm or multi near2 chip) and substrate	US-PGPUB; USPAT	OR	ON	2005/04/18 16:26
S17	13	flex$4 near2 (circuit or pcb or printed or pwb) and (mcm or multi near2 chip) and substrate and (terminal or ball) near2 pad and (connect$3 near2 pad) and staggered	US-PGPUB; USPAT	OR	ON	2005/04/18 16:27
S18	70	flex$4 near2 (circuit or pcb or printed or pwb) and (terminal or ball) near2 pad and (connect$3 near2 pad) and staggered and wiring	US-PGPUB; USPAT	OR	ON	2005/04/18 16:51
S19	18	("5159535" | "5450283" | "5578525" | "5646446" | "5773882" | "5783870" | "5949142" | "5969426" | "6071755" | "6075287" | "6208521" | "6324067").PN. OR ("6486544").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/18 16:33
S20	17	("5483024" | "5583375" | "5939779" | "6002167" | "6080931" | "6087718").PN. OR ("6177721"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/18 16:35
S24	2	("6576992").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/18 16:38
S26	41	(terminal or ball) near2 pad and (connect$3 near2 pad) and staggered and (mcm or multi near2 chip) and stack$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/19 14:10

S27	49	(terminal or ball) near2 pad and (connecting near2 pad) and staggered and stack$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/18 16:45
S28	25	(terminal or ball) near2 pad and (connecting near2 pad) and staggered and (csp or chip near2 scale near2 package)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/18 16:48
S29	1195	flex$4 near2 (circuit or substrate or cable or wir$3 or structure or rigid) and substrate and (chip or ic or "integrated circuit") and (terminal near2 pad)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/18 16:54
S30	456	flex$4 near2 (circuit or substrate or cable or wir$3 or structure or rigid) and substrate and (chip or ic or "integrated circuit") and (terminal near2 pad) and stack$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/18 16:54
S32	22	"6576992"	US-PGPUB; USPAT	OR	ON	2005/04/19 10:05
S34	5321	(edge near2 pad) and (ic or "integrated circuit" or chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/19 11:02
S35	1512	("edge pad") and (ic or "integrated circuit" or chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/19 11:02
S36	282	("edge pad") and (ic or "integrated circuit" or chip) and stack$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/19 11:04
S37	156	("edge pad") and (ic or "integrated circuit" or chip) and stack$3 and via	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/19 11:15

S38	144	("edge pad") and ("area array" or csp or "chip scale package" or bga or "ball grid array")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/19 11:16
S39	120	("edge pad") and ("area array" or bga or "ball grid array")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/19 11:16
S40	8	(("20010040282") or ("6576992") or ("20020043702") or ("20020030261")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/19 14:10
S42	2	("5625221").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/19 17:30
S43	0	("2001/0040282").URPN.	USPAT	OR	ON	2005/10/20 12:54
S44	104	("4371912" | "4638348" | "4761681" | "4841355" | "4868712" | "4956694" | "5012323" | "5128831" | "5231304" | "5239447" | "5266912" | "5299092" | "5311401" | "5313096" | "5373189" | "5384689" | "5400003" | "5616958" | "5625221" | "5637536" | "5639695" | "5639696" | "5642261" | "5648679" | "5668405" | "5675180" | "5677566" | "5804874" | "5815372" | "5835988" | "5844315" | "5883426" | "5903049" | "5994166").PN. OR ("6072233").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/20 12:56

S45	89	("5128831" | "5518957" | "5593927" | "5677566" | "5696033" | "5739585" | "5793939" | "5851845" | "5891753" | "5893726" | "5898224" | "5933713" | "5938956" | "5946553" | "5958100" | "5986209" | "5989941" | "5990566" | "5994784" | "6008070" | "6008074" | "6020624" | "6020629" | "6025728" | "6028365" | "6046496" | "6048744" | "6048755" | "6049125" | "6051878" | "6072233" | "6072236" | "6075288" | "6097087" | "6103547" | "6107122" | "6107680" | "6117382" | "6124634" | "6130823" | "6147411" | "6150717" | "6153928" | "6159764" | "6172419" | "6175149" | "6181569" | "6184465" | "6198172" | "6208519" | "6210992" | "6212767" | "6215175" | "6225689" | "6228548" | "6229202" | "6235554" | "6246108" | "6258623" | "6258624" | "6259153" | "6277671" | "6284571" | "6291894" | "6294839" | "6297547" | "6303981" | "6303985" | "6310390" | "6314639" | "6316285" | "6326242" | "6326244" | "6326687" | "6326697" | "6326698" | "6329220" | "6331221" | "6331453" | "6332766" | "6482680" | "6552910" | "6560117" | "6582991" | "6589820" | "6664139" | "D394844" | "D402638" | "RE36469").PN. OR ("6924550").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/20 13:16
S46	2	("6,740,546").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/20 13:16
S47	12	("5608265" | "5763939" | "5952611" | "5999413" | "6020637" | "6072233" | "6144102" | "6150730" | "6326700" | "6462274").PN. OR ("6528722"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/21 14:14